

# IRS20752LPBF

# μΗVIC<sup>™</sup>

# SOT-23 High-Side Gate Driver IC

# Features

- Floating gate driver designed for bootstrap operation
- Fully operational to +200 V .
- Excellent dv/dt immunity •
- Excellent negative Vs transient immunity
- Wide V<sub>CC</sub> range •
- UVLO on low-side and high-side
- Schmitt-trigger input with internal pull-down
- Output in phase with input
- Excellent latch immunity on all inputs & outputs
- **RoHS** compliant •
- 6-pin SOT-23 package

#### Applications

- High-side gate driver control •
- Pulse transformer replacement
- General purpose switched mode power electronics

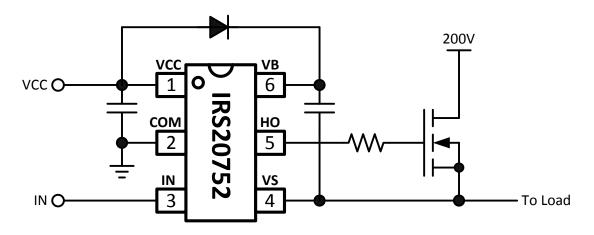
# Description

The IRS20752 is a high-side, single-channel gate driver IC with 200V blocking and levelshifting capability. This allows for the gate driver to be connected directly to the gate of a high-side power MOSFET, while being controlled by the low-side, ground potential circuitry. The IRS20752 includes a wide V<sub>CC</sub> supply range, UVLO protection, and excellent immunity to harsh dv/dt or -Vs switching environments. IR's HVIC technology allows for these functions and features to be realized in a 6-pin SOT-23 package.

## **Package Options**



# **Typical Connection Diagram**



#### **Ordering Information**

		Standar	d Pack		
Base Part Number	Package Type	Form	Quantity	Orderable Part Number	
IRS20752LPBF	SOT-23-6L	Tape and Reel	3000	IRS20752LTRPBF	



Table of Contents	Page
Description	1
Ordering Information	1
Typical Connection Diagram	1
Absolute Maximum Ratings	3
Recommended Operating Conditions	3
Electrical Characteristics	4
Functional Block Diagram	5
Timing Diagram	6
Lead Definitions	7
Lead Assignments	7
Package Details: 6L-SOT23	9
Tape and Reel Details: 6L-SOT23	10
Part Marking Information	12
Qualification Information	13



#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any pin. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition		Min	Max	Units
V <sub>B</sub>	High side floating absolute voltage		-0.3	220	
Vs	High side floating supply offset volta	age	V <sub>B</sub> - 20	V <sub>B</sub> + 0.3	
V <sub>HO</sub>	High side floating gate drive output voltage		V <sub>S</sub> - 0.3	V <sub>B</sub> + 0.3	N
V <sub>CC</sub>	Low side and logic fixed supply voltage		-0.3	20	- V
V <sub>IN</sub>	Logic input voltage		COM - 0.3	V <sub>CC</sub> + 0.3	
СОМ	Logic ground		V <sub>CC</sub> - 20	V <sub>CC</sub> + 0.3	
dVS/dt	High side floating supply offset voltage slew rate			50	V/ns
R <sub>ØJA</sub>	Thermal resistance, junction to ambient	6L-SOT-23		151	°C/W
TJ	Junction temperature		-55	150	
Ts	Storage temperature		-55	150	°C
TL	IC Pin temperature (soldering, 10 seconds)			300	1

#### **Recommended Operating Conditions**

For proper operation the device should be used within the recommended conditions.

Symbol	Definition	Min	Max	Units
V <sub>B</sub>	High side floating absolute voltage	V <sub>s</sub> + 10	V <sub>s</sub> + 18	
Vs	High side floating supply offset voltage	COM - 8 <sup>†</sup>	200	
V <sub>HO</sub>	High side floating gate drive output voltage	Vs	V <sub>B</sub>	V
V <sub>cc</sub>	Low side and logic fixed supply voltage	10	18	
V <sub>IN</sub>	Logic input voltage	СОМ	V <sub>cc</sub>	
TJ	Junction temperature	-40	125	°C

 $^{\dagger}$  Logic operational for V\_{S} of -8V to +200V. Logic state held for V\_{S} of -8V to -V\_{BS}.



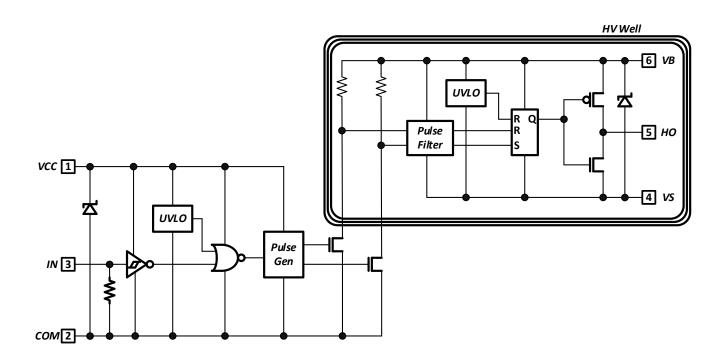
#### **Electrical Characteristics**

 $V_{CC}{=}15V,\,V_{BS}{=}15V,\,C_{L}{=}1000pF,\,and\,T_{A}{=}25~^{\circ}C$  unless otherwise specified.

Symbol	Definition	Min	Тур	Мах	Units	<b>Test Conditions</b>
Low Side Ch	aracteristics					
V <sub>CCUV+</sub>	V <sub>CC</sub> supply UVLO positive-going	8.0	9.0	10.0	V	
V <sub>CCUV-</sub>	V <sub>CC</sub> supply UVLO negative-going	7.0	8.0	9.0	v	
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> supply current		100		μA	
$V_{CC\_CLAMP}$	V <sub>CC</sub> internal Zener clamp voltage		20.4			$I_{CC} = 5mA$
V <sub>IH</sub>	Logic "1" input voltage			2.2	V	
V <sub>IL</sub>	Logic "0" input voltage	0.8				
I <sub>IN+</sub>	Logic "1" input bias current		20	40		$V_{IN} = V_{CC}$
I <sub>IN-</sub>	Logic "0" input bias current			5	μA	$V_{IN} = COM$
High Side Cl	naracteristics	• • • • •				
V <sub>BSUV+</sub>	V <sub>BS</sub> supply UVLO positive-going	8.0	9.0	10.0		
V <sub>BSUV-</sub>	V <sub>BS</sub> supply UVLO negative-going	7.0	8.0	9.0	V	
$V_{BS\_CLAMP}$	V <sub>BS</sub> internal Zener clamp voltage		20.4			I <sub>BS</sub> = 5mA
V <sub>OH</sub>	High level output voltage (V <sub>B</sub> – HO)		0.8	1.4		$I_0 = 2mA$
V <sub>OL</sub>	Low level output voltage (HO – $V_S$ )		0.3	0.6		
I <sub>LK</sub>	Offset supply leakage current			50		$V_B = V_S = 200V$
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> supply current		80		μA	$V_{IN} = V_{CC}$ or COM
Gate Drive C	haracteristics					
t <sub>ON</sub>	Turn-on propagation delay		140			$V_{S} = 0V$
t <sub>OFF</sub>	Turn-off propagation delay		215		ns	V <sub>S</sub> = 200V
t <sub>RISE</sub>	Turn-on rise time		85			
t <sub>FALL</sub>	Turn-off fall time		40			$V_{S} = 0V$
I <sub>O+</sub>	HO gate drive output source current		160			
I <sub>O-</sub>	HO gate drive output sink current		240		mA	

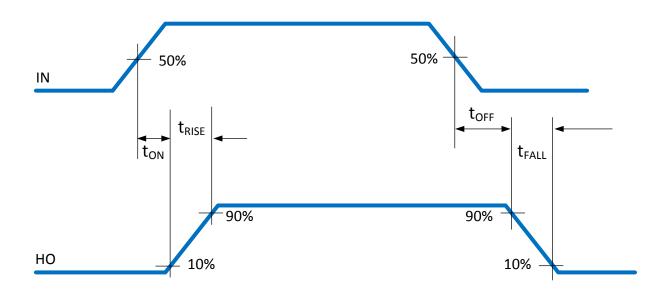


#### **Functional Block Diagram**





# **Timing Diagram**

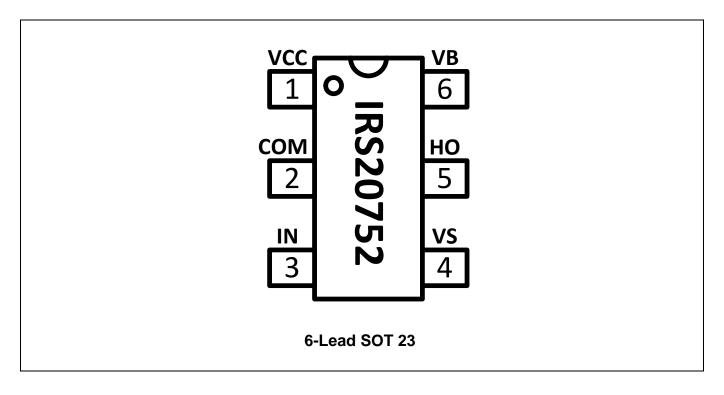




# **Pin Definitions**

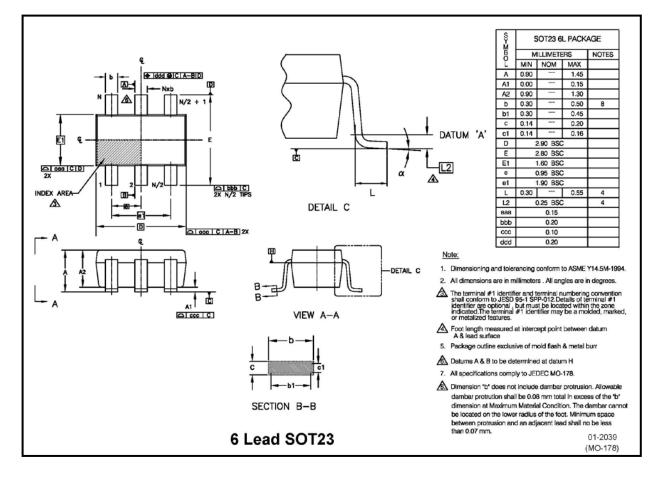
Pin	Symbol	Description	
1	VCC	IC supply voltage	
2	СОМ	IC power and signal ground	
3	IN	Logic input	
4	VS	High side floating supply offset voltage	
5	НО	High side gate driver output	
6	VB	High side floating supply voltage	

#### **Pin Assignments**



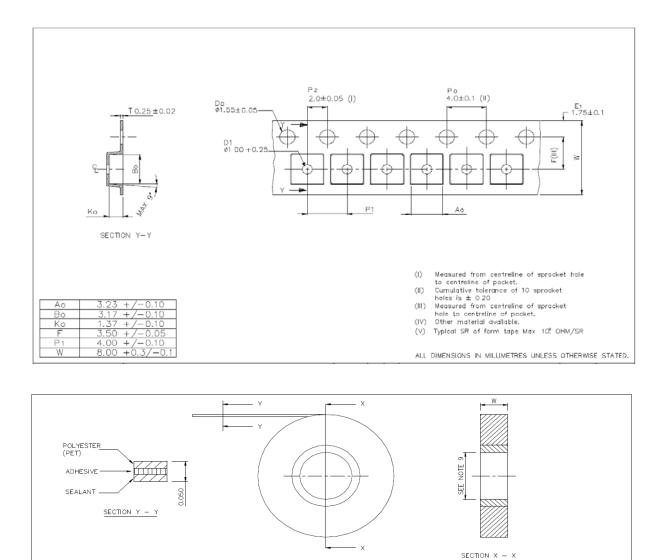


#### Package Details: 6L-SOT23





#### Tape and Reel Details: 6L-SOT23



NOTES

2

3

4

5

6

THICKNESS : 0.040 - 0.060

ELONGATION : ≥80%

LENGTH : 500 +2/-0 m , OUTER DIAMETER : 215mm MAX. TENSILE STRENGTH :  $\geqslant 6.50~{\rm kg/mm}$  sq.

SURFACE RESISTIVITY : ≤10E11 OHMS/SQ (BOTH SIDES) (ANTH-STATIC) PEEL STRENGTH CONFORMS TO EIA SPEC.

6 PFEL STRENGTH CONFORMS TO EIA SPEC. 7 RECOMMENDED SHELF LIFE : TWO YEAR FROM MANUFACTURING DATE 8 LUMINOUS TRANSMITTANCE : >80 % 9 3 INCH INTERNAL DIAMETER : @76.5±1.0 2 INCH INTERNAL DIAMETER : @50+1.7/-0 \*10 OTHER COVER TAPE WIDTH REFER TO W4.08-04.

ALL DIMENSIONS IN MILLIMETRES UNLESS OTHERWISE STATED.

COVER TAPE WIDTH\* ( W ±0.1 )

9.2, 9.5

13.3, 13.5 21.0, 21.3

25.5. 26.8

37.5 49.5 CARRIER TAPE

WIDTH

8

12

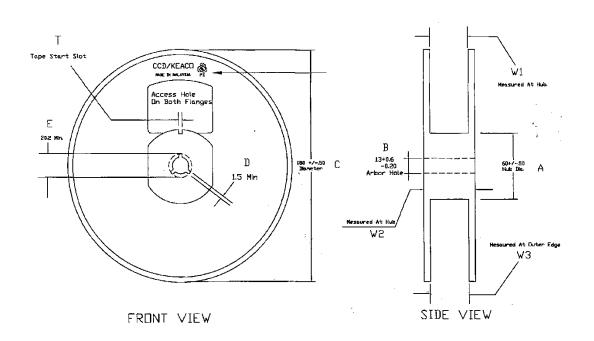
16 24

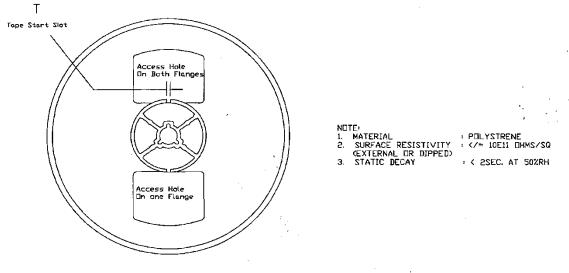
32 44



IRS20752LPBF

#### Tape and Reel Details: 6L-SOT23





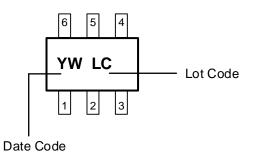
BACK VIEW



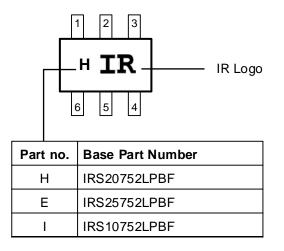


# Part Marking Information: 6 Lead SOT23

#### **Top Marking**



#### **Bottom Marking**





## **Qualification Information**<sup>†</sup>

Qualification Level		(pe	Industrial <sup>††</sup> (per JEDEC JESD 47E)			
		Comments: This family of ICs has passed JEDEC's Industrial qualification. IR's Consumer qualification level is				
			granted by extension of the higher Industrial level.			
Moisture Sensitivity Level		SOT-23	MSL1 <sup>†††</sup> (per IPC/JEDEC J-STD-020C)			
	Machine Model		Class B			
ESD		(per JEDEC s	(per JEDEC standard EIA/JESD22-A115-A)			
230	Human Body Model		Class 1B			
	Human Body Model	(per EIA/JED	(per EIA/JEDEC standard JESD22-A114-B)			
IC Latch-Up Test			Class I, Level A			
			(per JESD78A)			
RoHS Compliant			Yes			

† Qualification standards can be found at International Rectifier's web site http://www.infineon.com/

- ++ Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- +++ Higher MSL ratings may be available for the specific package types listed here. Please contact your International Rectifier sales representative for further information.

#### **Revision History**

Date	Comment
01/04/2017	<ul> <li>Updated "Infineon" logo –all pages.</li> <li>Added disclaimer on last page.</li> <li>Updated part marking information on page 11.</li> </ul>



Published by Infineon Technologies AG 81726 Munich, Germany © Infineon Technologies AG 2016 All Rights Reserved.

#### **IMPORTANT NOTICE**

The information given in this document shall in <u>no event</u> be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie"). With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies office (<u>www.infineon.com</u>).

#### WARNINGS

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may <u>not</u> be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.